Sarn Kon SMT / THT Assembly Line

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Overview

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& Optional
Services

Highlights

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Overview





HIGH CAPACITY



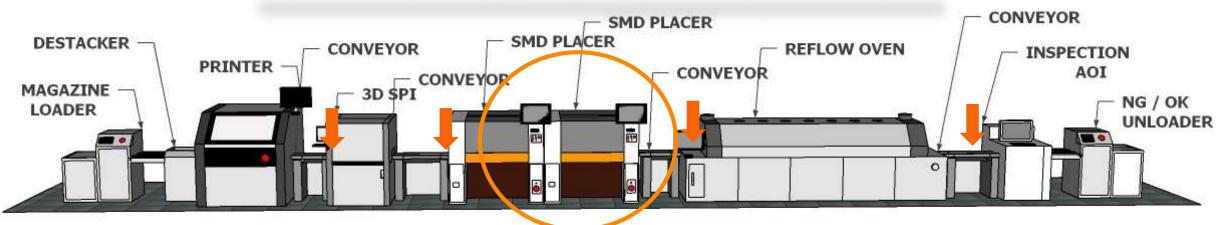
SHORT LEADTIME



HIGH QUALITY



FULL AUTOMATIC LINE





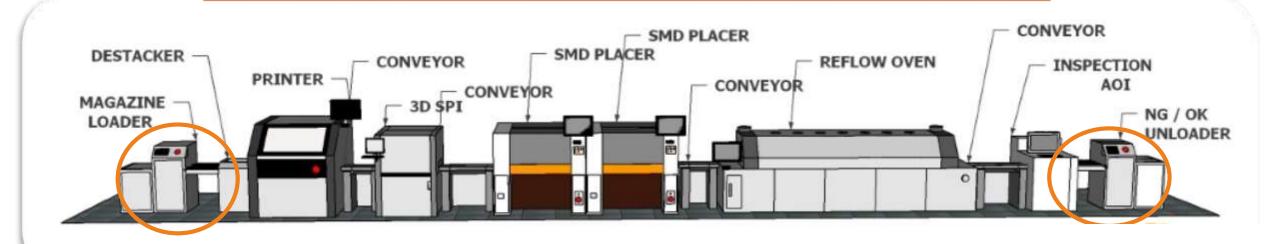
Double SMD Technology

220.000

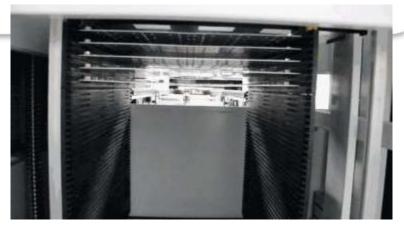
component /hour



ONTOUCHED PRODUCTION

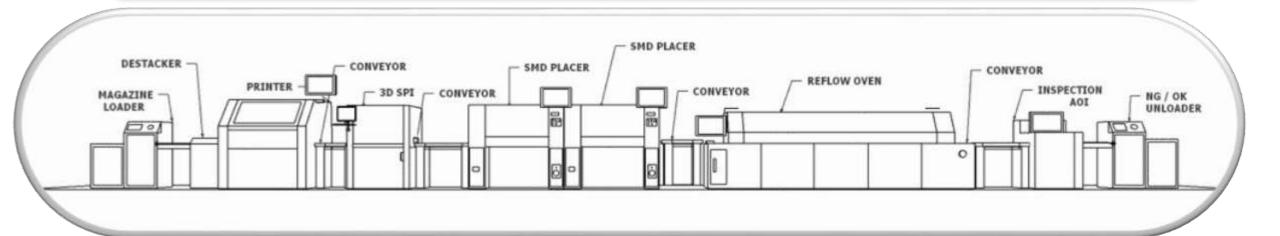








The Machine Range Produce High Quality





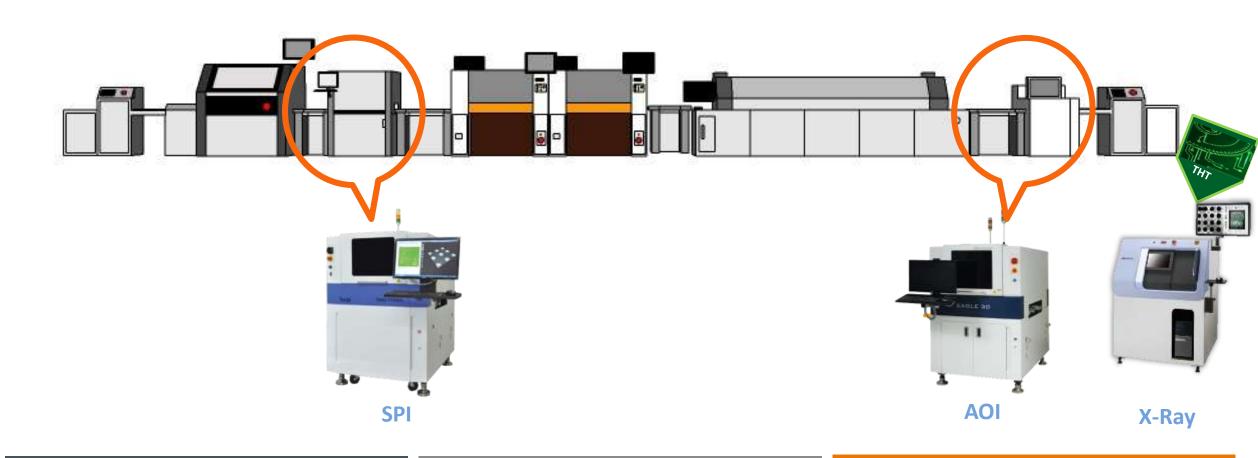






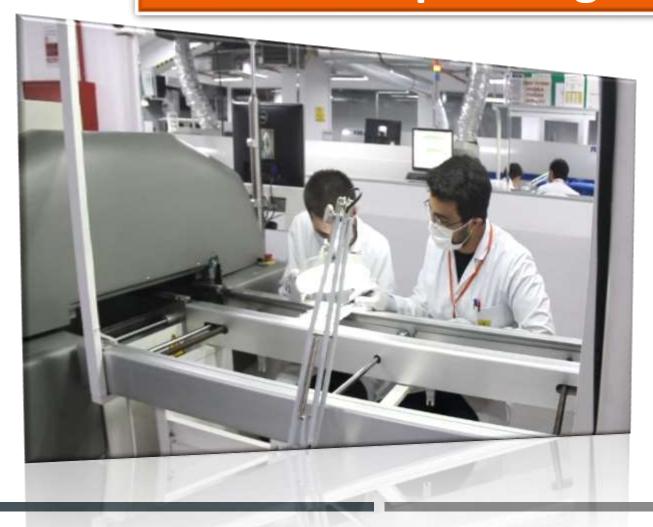
Selective Soldering

Quality Control Machines





Expert Engineer Team









MACHINE PARK



Automatic Loader Machine





w/o operator, untouched loading

Printing Machine



CreamSolder: Lead-freecreamsolder that we use in production is Alpha brand. It is one of the top 3 markers in the soldering industry. The most of prefered model sare SAC305 and SAC307 SAC305 has %3 silver weight and it is often used to produce electronic card for White goods and TV. For the LED Lighthing sector SAC07 is preferred because of %0,3 silver weighton the creamsolder

Full Automatic

Operator free unthouched production

1200 mm panel

Ability soldering 1200 mm length card

Perfect Printing

Can read the reference (Fiducial) points, makes direction verification and centering.





%64

OF THE ERRORS THAT OCCUR IN SMD PRODUCTION ARE CAUSED BY SOLDERING.

SPI (Solder Paste Inspection) Machine



3 D Control

Combines **2D color images with 3D measurement** data to provide more detailed, near-real PCB images, unlike traditional color maps.

Our machine also provides with the best solution for **high-quality and high-precision PCB production** with a variety of statistical programs, along with information you need to quickly and accurately judge positive/failure

%100 Control

- Verify whether the soldering paste is present and has been applied exactly
- Checks the accuracy (quantity and height) of the soldering process.
- This control makes 100% on all pads on the panel (PCB).

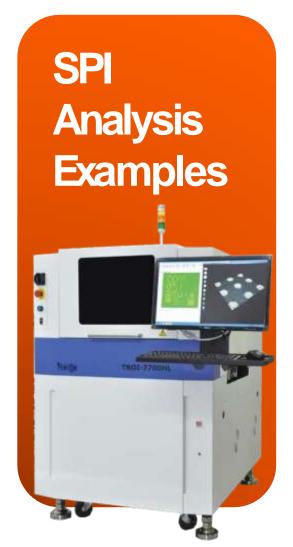


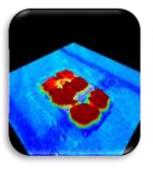
SPI Analysis

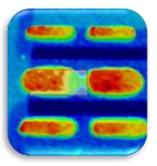


- ✓ Short Circuit Control
- ✓ Solder Control
- ✓ Stained Sieve Control
- ✓ Reference Point Control
- ✓ Soldering Position Control
- √ Solder Area Control
- ✓ Solder Height Control
- ✓ Solder Form /Shape Control
- ✓ Solder Volume Control

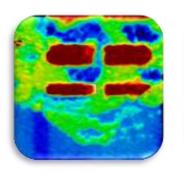








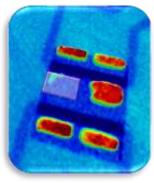
Short Circuit Control

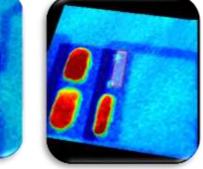


Stained Sieve Control

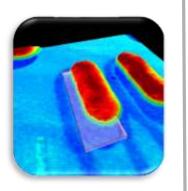


Solder Shape Control





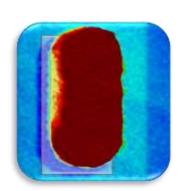




Solder Position Control



Reference Point Control



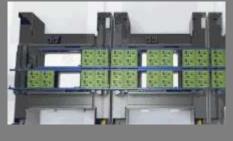
Solder Form Control



High Capacity &
Fast Production

220.000 component /hour Duallane conveyor system

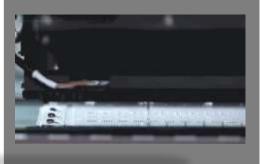
Double Head





Safe & Sensitive Production

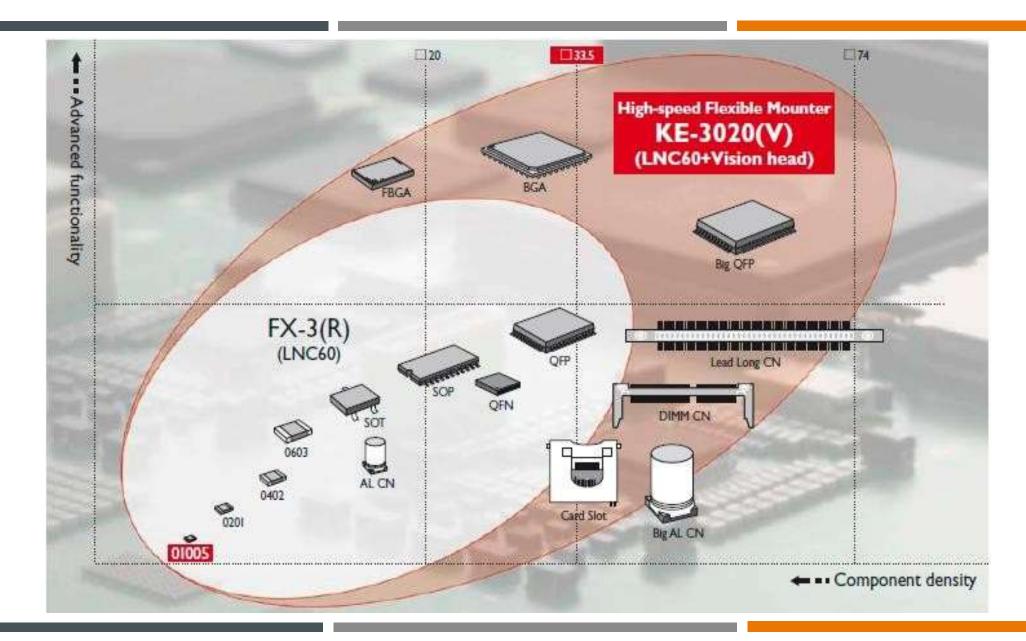
- Flying Vision Camera
 System
 - Electronic Feeder



Flexible Component Assembly

No: 01005 Component 1200 mm card







Reflow Owen



Ideal Zone Number/ Length

•It has the number of zones (as heating / cooling) and length that provide the most suitable conditions for the LED assembling.

1200 mm card

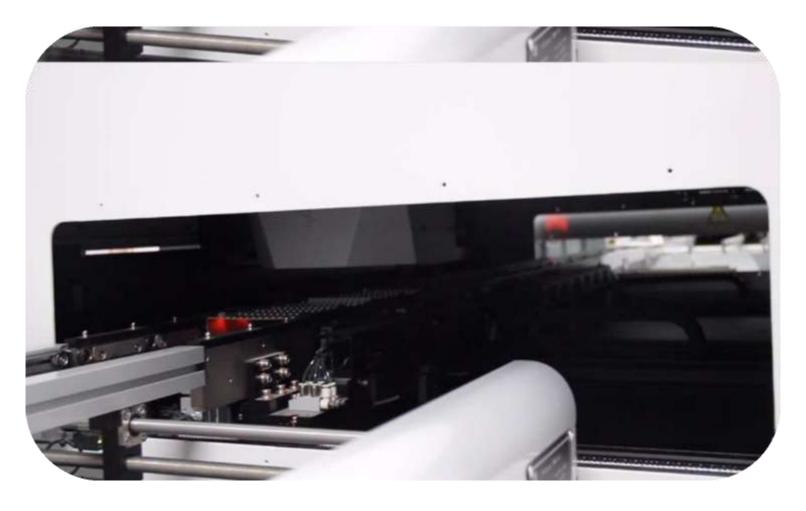
Able to assemble up to 1200 mm long panel

Heat Measurement Device

Since the temperature values are very important in soldering, it makes weekly measurements according to the solder and pcb used with our heat profile measurement device and ensures heat stability and accuracy in standard products. In the new product, it determines the temperature value needed by measuring the temperature.

sarnikon

AOI (Automatic Optic Inspection) Machine



%100 Control with 3D

8-way projection for <u>3D measurements</u> to all models, minimizing shadow effects errors and **performing 100**% 2D&3D examinations simultaneously in all FOV areas

High Speed Control

- Sensivity: 10-15-18 um
- · Component are missing and incorrectly mounted,
- Solder climbs can be recognized very quickly.

1200 mm card Control

- It can control cards up to min. 50x50 mm /max:1200 x650 mm long.
- Inspecting up to 30mm in height components

Perfect Analysis

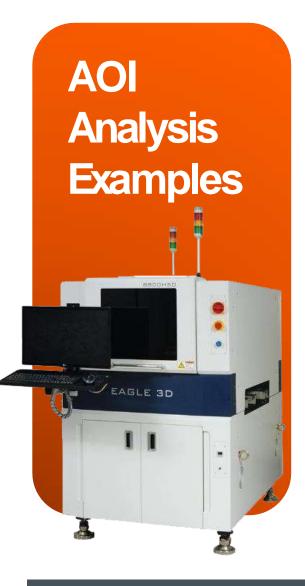
Machine can separate all cards according to OK / NG (no go) result itself at the end of control process.

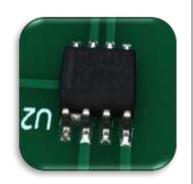


AOI **Analysis**



- ✓ Missing Component
- ✓ Shifted Component
- ✓ Short Circuits
- √ Component w/o Solder
- ✓ Reverse Component
- ✓ Wrong Component✓ Height of Components- with 3D only





Short Circuits



Solderless Pad

Detection



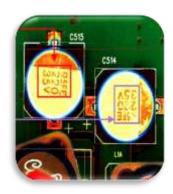
Component Control



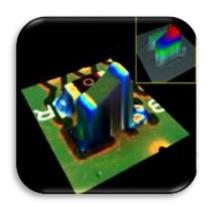
Shifted Component



Axial Offset Control
(Y)



Text Control



Height of Components







Automatic Unloader Machine





w/o operator, untouched unloading

Soldering in **narrow areas** of electronic cards





- Missing Sølder
- Excess Solder
- Cold Solder
- Short Circuit
- Card Pollution





Selective Soldering Machine

Perfect & Fast Soldering



Selective flux system advantage

There is no need for the cleaning process, no soldering breakages that may occur.



Optimal homogeneo us preheating

The solder connection of the island and component legs to be soldered on the PCB is brought to the thermal regime, ensuring



Soldering module X / Y / Z variable

Safe / error-free component soldering is provided with automatic adjustment with Gerber file support.



Nozzle Selection Setting

The process time is shortened by multiple soldering by selecting suitable sizes of nozzles.

solder materials



X- Ray Control

SAKI Corporation/ Japan

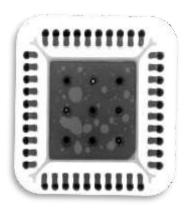




- ✓ Error Analysis of Very Intensive Cards
- ✓ State the possible air gaps in the solder points
- ✓ Point Analysis of BGA, micro BGA, QFN, LED, lc, Leg component.
- ✓ Volume Calculations of High Precision Void.

X-Ray Control Examples/1





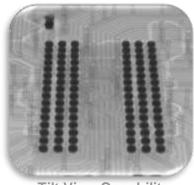
QFN Inspection



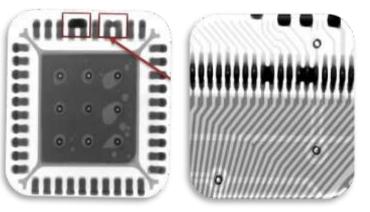
SOT89 Inspection



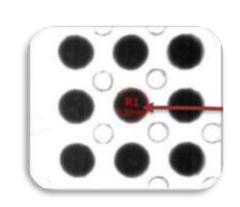
Components mounted incorrectly Incorrect placement of solder masks



Tilt View Capability
All components can be inspected from 1to 60 tilt



Short Circuit Control



Solder-Pad Width Control



Dropped SMD Chip Under BGA



X-Ray Control Examples/2

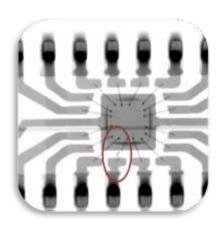




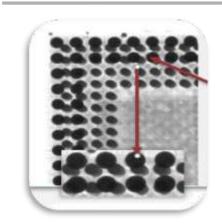
Missing Solder Balls



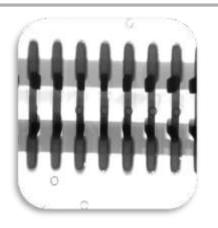
Cold Solder Joints



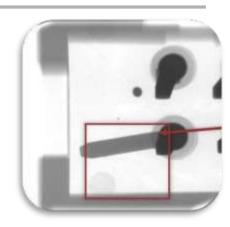
Broken Wire Inspection



BGA Via Open and Poor Plating



BGA Via Open and Poor Plating



Bending Pin Inspection

Total Quality Management



- Neccesary ventilation to make sure production area clean & hygenic.
- Infrastructure ESD (antistatic) supported epoxy floor.
- Lowelectric load, moisture and dust value in environment.



ISO 9001:2015

Quality Management System

ISO 14001:2015

Enviromental Management System

ISO 10002:2018

The Customer Satisfaction and Compliance
Management System

LED Light For You

Certified Partner for Region of EUROPE

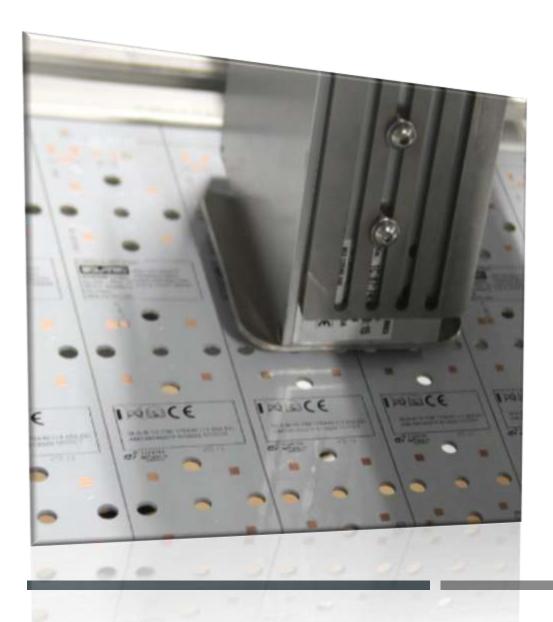






Optional Services

Optional Services



Labelling

2-axis printing capability

Printing matrix or QR code min.4 mmx4 mm area. With our labelling machine,

- We are capable of making custom design marking.
 Customized marking can be text, brand, date of manufacture, article number.
- Colorful editing can be done.
- We have oppurtunity to make product traceability and simplified quality assurance



Optional Services



Safety Test

We can also test 62031 Led Modules in 60598 standards for the led modules that come out of our production according to customer requests.

V –Cut Service

We can also test 62031 Led Modules in 60598 standards for the led modules that come out of our production according to customer requests.





Special Packaging

The products can be delivered in ESD protected packaging and delivered according to the customer's request.



Have You Asked These?

1. Which brand of solder cream are you using?



We use long-lasting British Brand Alpha lead-free cream solder. Quality soldering is guaranteed. We prefer solder with different silver weight in LED lighting and electronic card assembly.

2. Is the printer manual, semi-automatic or fully automatic?



We are aware that the %64 of the errors due to solder problems, therefore, we use fully automatic printers. We prefer a fully automatic printer that can solder 120cm automatically at one time; whose investment cost is 60 times more than manual printers and 10 times more than semi-automatic printers.

3. How is the soldering quality gets controlled?



We own a SPI (Solder Paste Inspection) machine to inspect homogeneous solder dispersion. We control solder length, width and height with 3D Imaging technology to provide %100 solder quality.

4.To how much length, can SPI devices control cards at one time?



Can inspect boards with up to 120cm at one time, the only SPI machine in the World which is custom designed to do so.

5. What is your assembly capacity and what are your deadlines?

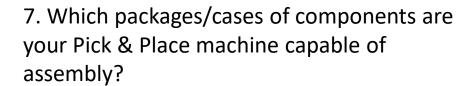


We provide high capacity and short delivery time with our line which has double SMD production technology (double head assembly & double machine) and double conveyor, which can assembly 220,000 components per hour <u>according to the IPC standards.</u>



Have You Asked These?

6. How many heating and cooling zones does your oven have?

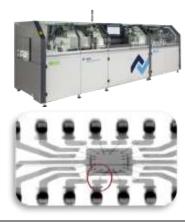


- 8. Do you own AOI (Automatic Inspection) machine ?
- 9. How do you Assembly THT components, by hand?
- 10. How do you Inspect the errors which can not be seen by naked eye?









We cook precisely with a total of 13 zones, which is the ideal zone number that makes the solder, liquid, by slowly melting it in a healthy way and leaving it to cool so that it does not form cracks. Thus, we are able to create special oven conditions for each card.

Our machine can assembly components in the package style from 01005 up to -74x74mm - 50x150 mm. Thanks to this feature, we can address different sectors such as automotive, medical and defense.

With our in-line AOI machine, we provide 100% control on each board. We take high resolution photographs and compare the cards produced with the witness sample. We prevent major errors by controlling also the height of the components with 3D technology.

With our Selective Soldering machine, which is a requirement for the automotive standards and used for THT assembly, we provide flawless and fast soldering. Hence, eliminating human erros.

With our X-Ray device, by looking at the internal structure of the components and the solder, we are able to detect problems such as solder coating bubbles, broken wires in the component, short circuit between legs, and prevent them with the right machine adjustments. For example, we examine with an X-ray whether the contact between the PCB islands and the legs of the chip is fully established.



Have You Asked These?

11. Do you check for air bubbles inside the solder?



12. According to which standards do you follow up your assembly processes?



In-solder oxidation is the oxidation of air bubbles formed in the solder, over time. We control the number of the air bubbles according to the IPC standards.

IPC is the Rework, Repair and Modification Standard for Electronic Board Sets. We follow our processes and create our production rules according to the IPC Standards. Our staff consists of people who have received IPC training.

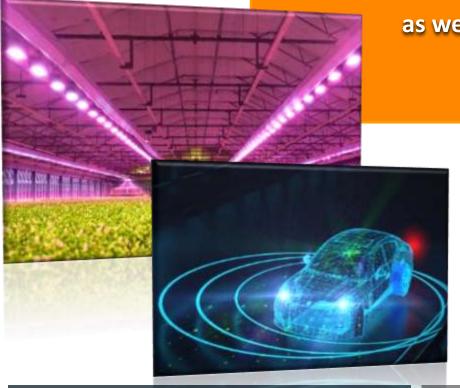


Our SMT/THT Assembly line is

pleased to provide electronic card assembling services for the

Automotive, Defense industry and IT sectors

as well as LED assembling for the lighting sector.





sarnikon

Thank you



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